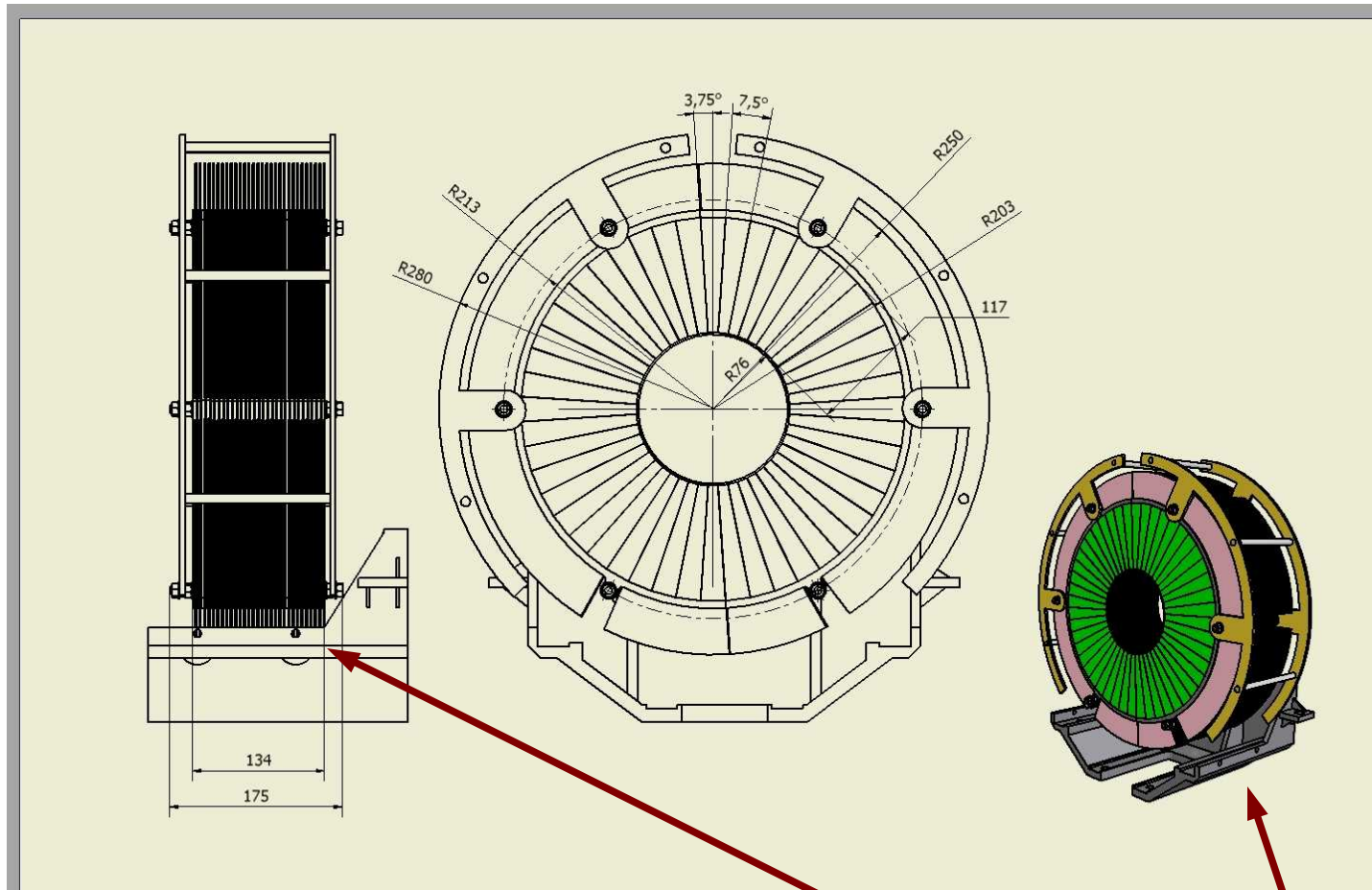


Connectivity issues for LumiCal (BeamCal) at ILC

- Readout electronics is taking shape
- We are starting to attack system problems (spatial constraints, cabling, connectors...)
- Why only now ? We are only few people

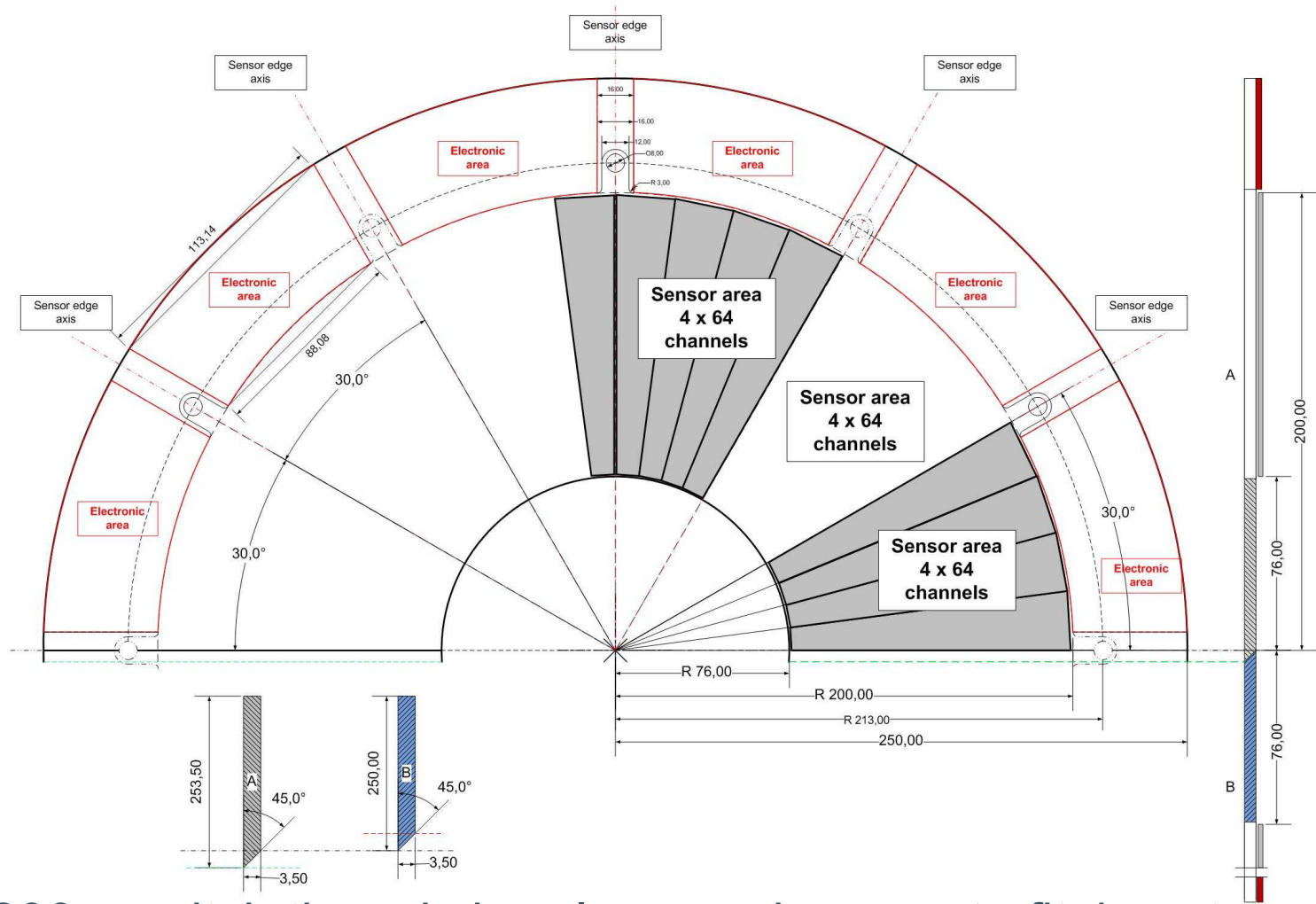
LumiCal detector



□((pad x 64=sector) x 48 = plane) x 30 = 92160, LumiCal barrel

□Constraints for electronics+cabling: thickness of single plane ~4.5mm, available space = few cm beyond R=20cm

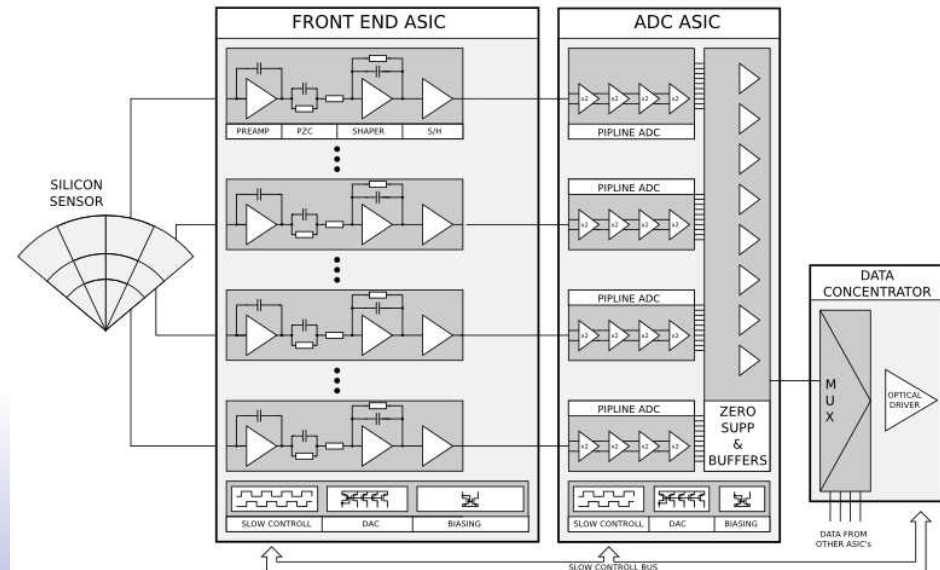
LumiCal detector half-plane



With 200um pitch there is barely enough space to fit 4 sectors (256 channels) between tungsten holders (at least 32 channels per ASIC)

Readout electronics

- ❑ Front-end ASICs 32(64) channels
- ❑ ADC ASICs 32(64) channels
- ❑ Data concentrator FPGA (or ASIC) per ~4 sectors (256 chan), containing transmitter (differential wires to send out data)
- ❑ One of data concentrators/plane will collect and send out the data
- ❑ Low voltage (LV) power supply delivery (cables, connectors, regulators?)
- ❑ High voltage (HV) delivery



Main connectivity issues similar for LumiCal and BeamCal

- ❑ Sensor – front-end connection
- ❑ Sending data out of LumiCal (BeamCal) plane
- ❑ Delivering power supply (LV, HV)
- ❑ Testbeam temporary connectivity solutions
- ❑ Power pulsing will certainly add some problems...

Sensor-frontend connection

□ Kapton fanout

- +small C, +already existing

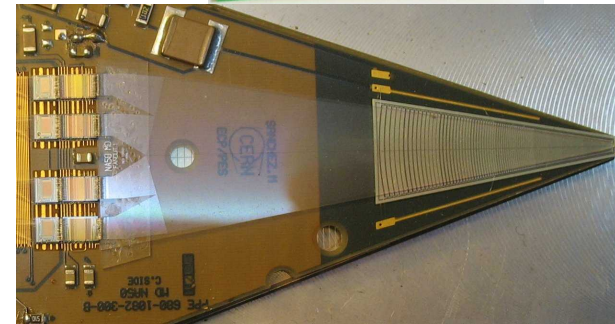
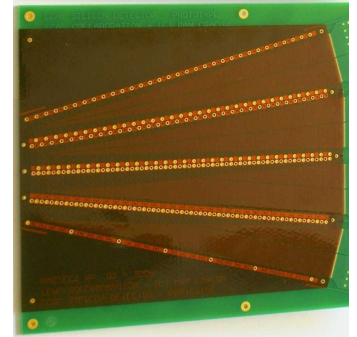
□ Glass fanout

- +small C, +rigid

□ Fanout integrated on sensor

- +fully integrated, -large C , L_{par} , R_{par} , -price

□ Other ?



NA50 example

Technology issues: bonding, bump-bonding ?

Sending Data out

□ LumiCal data rate per plane per train

- Worst case: $64\text{pad} \cdot 48\text{sec} \cdot 3000\text{bx} \cdot 10\text{bit} = 88\text{Mb}$,
TX between trains: $88\text{Mb}/200\text{ms} = 440\text{Mbit/s}$
- Average MC: $64 \cdot 48 \cdot 10\text{hit/train} \cdot 30\text{bit} = 0.9\text{Mb}$,
TX between trains: $0.9\text{Mb}/200\text{ms} = 4.5\text{Mbit/s}$

□ Data can be collected by single FPGA (or ASIC) per half-plane and send out by wires

Technology issues: thin connectors ?

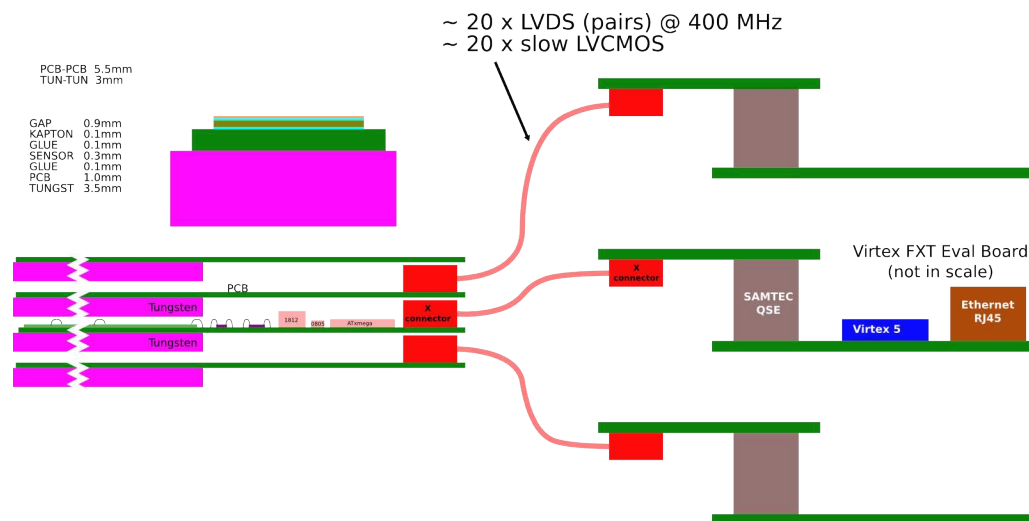
Power supply

- LV power consumption estimation per barrel
 - $\sim 15\text{mW/chan} \cdot 64\text{pad} \cdot 48\text{sec} \cdot 30\text{planes} = 1.4\text{kW}$,
 $1.4\text{kW}/3.3\text{V} > \mathbf{400A !}$
 - Regulators, what type, where ?
 - Power pulsing....
- HV power consumption is negligible, only HV isolation is an issue

Technology issues: cables/connectors ?

Testbeam issues

- ❑ On short term scale prototypes of LumiCal sectors will be read by standard FPGA evaluation boards
- ❑ Connectivity schemes need to be solved



Technology issues: thin dense connectors,
fast (~400MHz) wire connection ?

First Testbeam Setup

- ❑ PCB board with biasing circuitry
- ❑ Silicon sensor with fanout
- ❑ 5 front-end ASICs bonded
- ❑ External ADCs and the rest...

